

## Single line IPAD™, EMI filter including ESD protection

### Features

- High density capacitor
- 1 line low-pass-filter
- Lead-free package
- High efficiency in EMI filtering
- Very low PCB space consumption
- Very thin package: 0.65 mm
- High efficiency in ESD suppression (IEC 61000-4-2 level 4)
- High reliability offered by monolithic integration
- High density capacitor technology

### Complies with the following standards

- IEC 61000-4-2 level 4, on output pins
  - 15 kV (air discharge)
  - 8 kV (contact discharge)
- IEC 61000-4-2 Level 1, on input pins
  - 2 kV (air and contact discharge)

### Application

- Single ended microphone in mobile phones and portable devices

### Description

The EMIF01-SMIC01F2 is a highly integrated device designed to suppress EMI/RFI noise for microphone line filtering.

The EMIF01-SMIC01F2 Flip Chip packaging means the package size is equal to the die size. That is why EMIF01-SMIC01F2 is a very small device.

Additionally, this filter includes ESD protection circuitry which prevents damage to the application when subjected to ESD surges up to 15 kV.

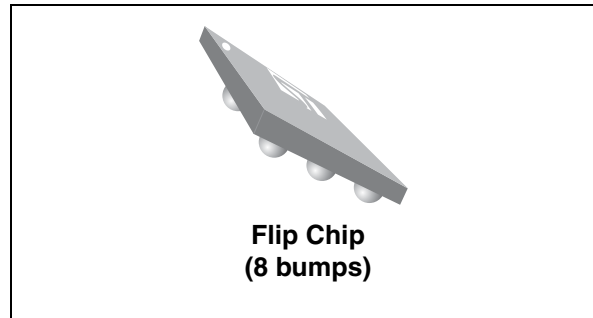


Figure 1. Pin configuration (bump side)

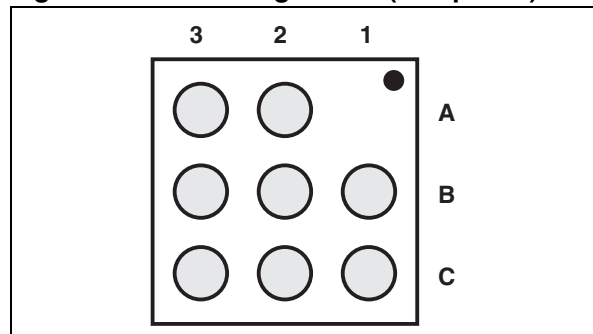
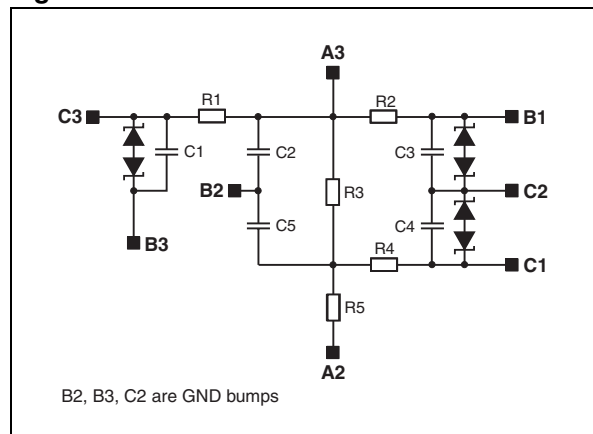


Figure 2. Schematic



TM: IPAD is a trademark of STMicroelectronics

# 1 Characteristics

**Table 1. Absolute maximum ratings ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ )**

| Symbol    | Parameter and test conditions                 | Value         | Unit               |
|-----------|---|---------------|--------------------|
| $V_{PP}$  | Output lines (C3)                             |               |                    |
|           | ESD discharge IEC61000-4-2, air discharge     | 15            |                    |
|           | ESD discharge IEC61000-4-2, contact discharge | 8             |                    |
|           | Input lines (A3, A2, B1, C1)                  |               |                    |
|           | ESD discharge IEC61000-4-2, air discharge     | 2             |                    |
|           | ESD discharge IEC61000-4-2, contact discharge | 2             |                    |
| $T_j$     | Maximum junction temperature                  | 125           | $^{\circ}\text{C}$ |
| $T_{op}$  | Operating temperature range                   | - 40 to + 85  | $^{\circ}\text{C}$ |
| $T_{stg}$ | Storage temperature range                     | - 55 to + 150 | $^{\circ}\text{C}$ |

**Table 2. Electrical characteristics ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ )**

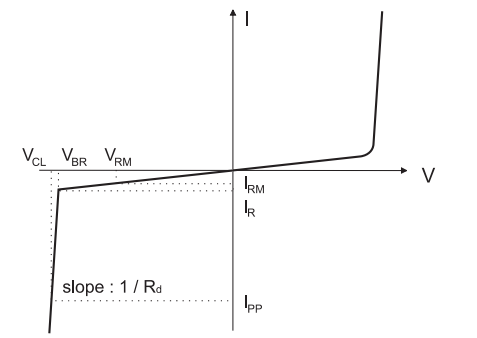
| Symbol               | Parameter   |  |      |      |               |
|----------------------|---|---|------|------|---------------|
| $V_{BR}$             | Breakdown voltage   |   |      |      |               |
| $I_{RM}$             | Leakage current @ $V_{RM}$  |   |      |      |               |
| $V_{RM}$             | Stand-off voltage   |   |      |      |               |
| $V_{CL}$             | Clamping voltage  |   |      |      |               |
| $R_d$                | Dynamic impedance   |   |      |      |               |
| $I_{PP}$             | Peak pulse current  |   |      |      |               |
| Symbol               | Test conditions   | Min.  | Typ. | Max. | Unit          |
| $V_{BR}$             | $I_R = 1\text{ mA}$   | 14  |      |      | V             |
| $I_{RM}$             | $V_{RM} = 3\text{ V per line}$  |   |      | 0.5  | $\mu\text{A}$ |
| $C_1, C_2, C_3, C_4$ | $V_{LINE} = 0\text{ V}, V_{OSC} = 30\text{ mV}, F = 1\text{ MHz}$ ,<br>Tolerance $\pm 20\%$ |   | 1    |      | nF            |
| $C_5$                | $V_{LINE} = 0\text{ V}, V_{OSC} = 30\text{ mV}, F = 1\text{ MHz}$ ,<br>Tolerance $\pm 20\%$ |   | 150  |      | pF            |
| $R_1, R_5$           | Tolerance $\pm 5\%$   |   | 50   |      | $\Omega$      |
| $R_2, R_3, R_4$      | Tolerance $\pm 5\%$   |   | 2.2  |      | k $\Omega$    |

Figure 3. Filtering measurements

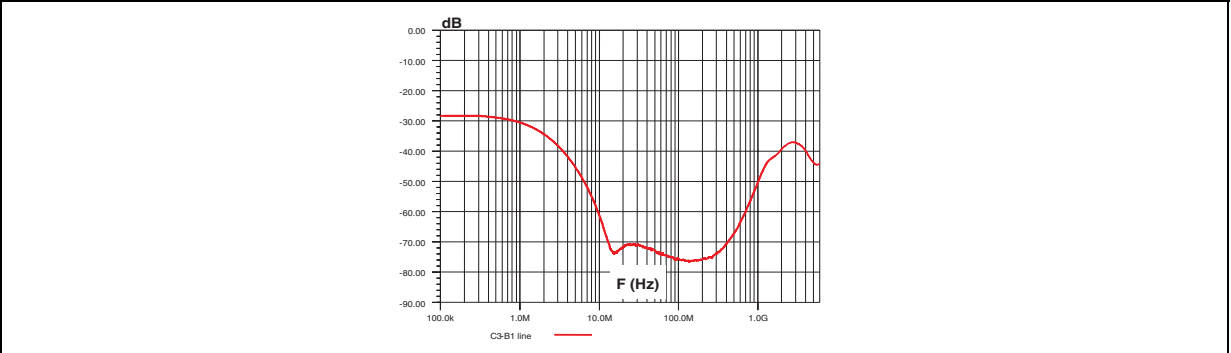


Figure 4. ESD response to IEC 61000-4-2 (+15 kV air discharge) on one output line

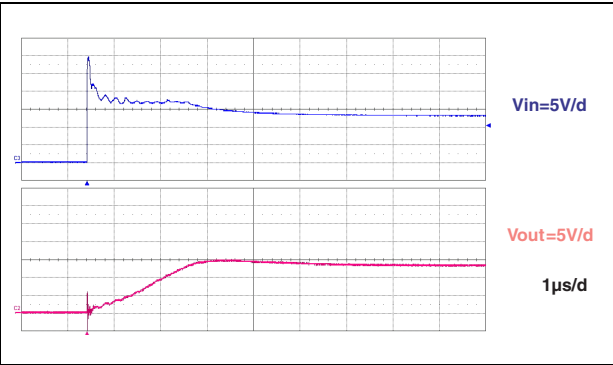
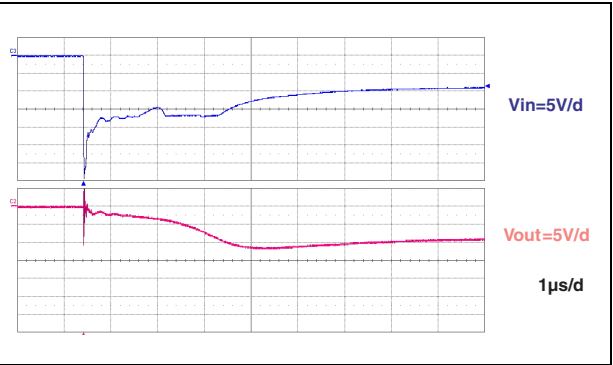
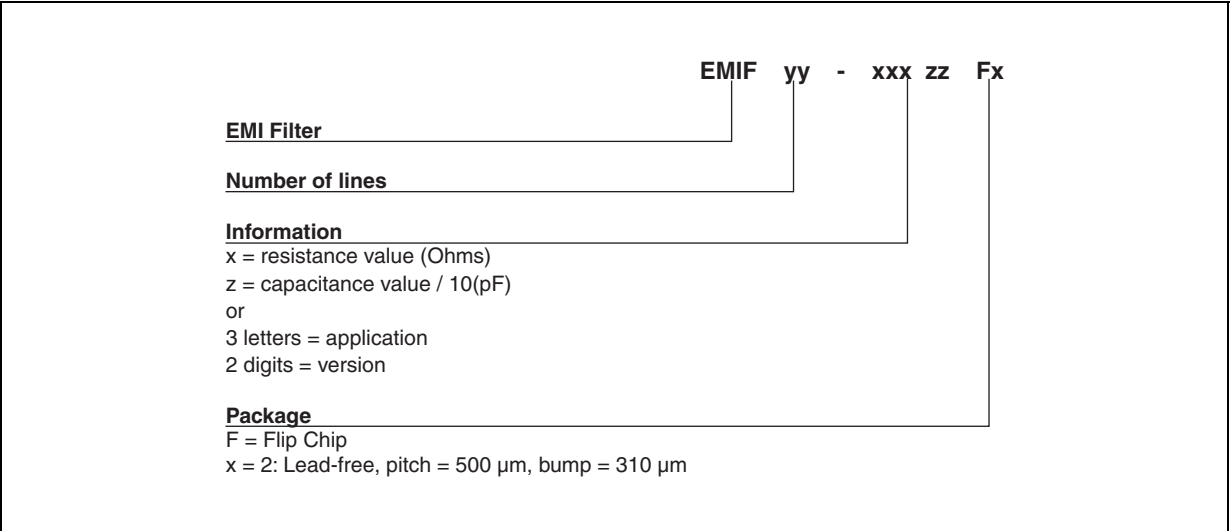


Figure 5. ESD response to IEC 61000-4-2 (-15 kV air discharge) on one output line



## 2 Ordering information scheme

Figure 6. Ordering information scheme



### 3 Package information

In order to meet environmental requirements, ST offers these devices in ECOPACK<sup>®</sup> packages. These packages have a lead-free second level interconnect. The category of second level interconnect is marked on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at [www.st.com](http://www.st.com).

Figure 7. Flip Chip dimensions

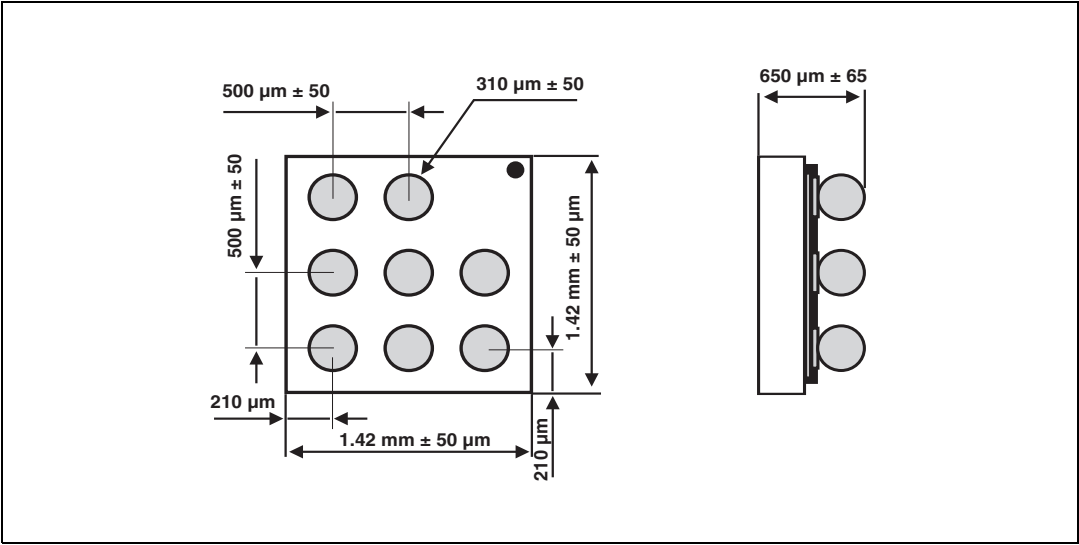


Figure 8. Flip Chip footprint

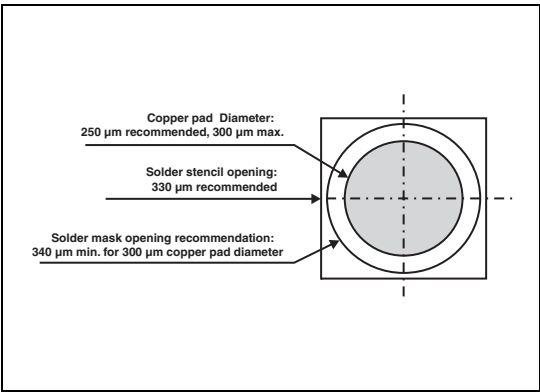
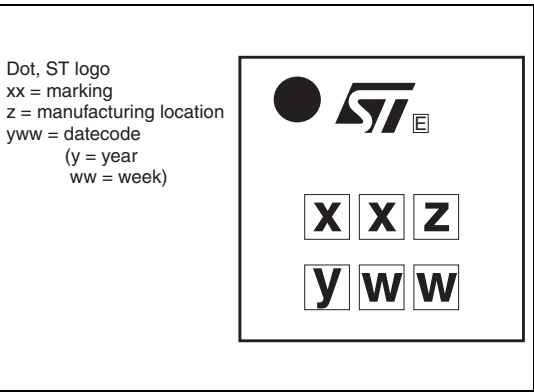
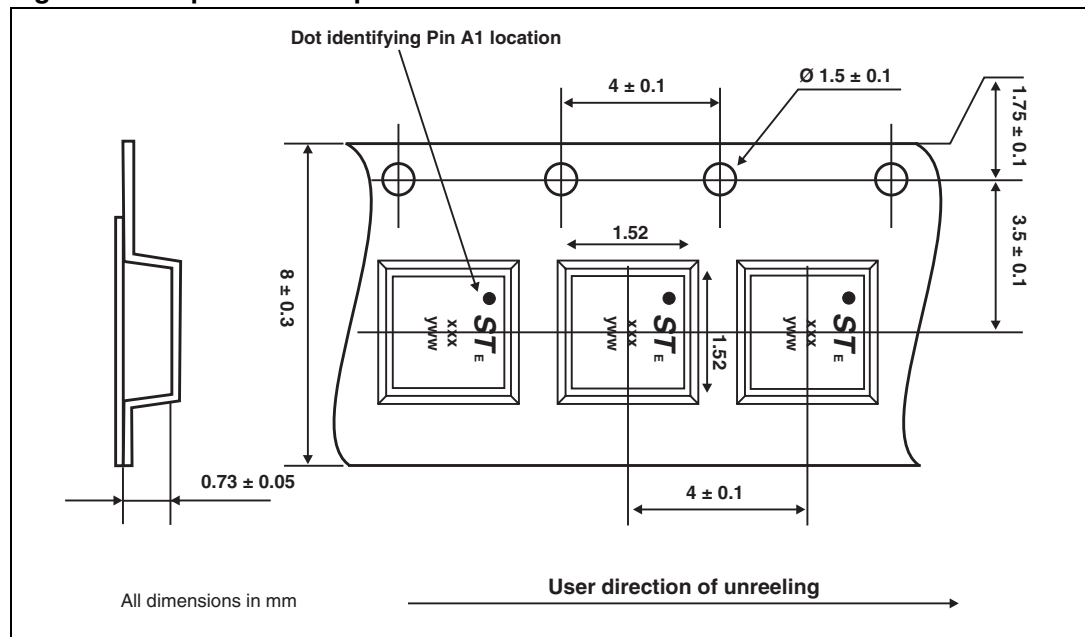


Figure 9. Marking



**Figure 10. Tape and reel specification**



*Note:*

*More packing information is available in the application notes:*

AN1235: "Flip Chip: Package description and recommendations for use"

AN1751: "EMI Filters: Recommendations and measurements"

## 4 Ordering information

**Table 3. Ordering information**

| Order code      | Marking | Package   | Weight | Base qty | Delivery mode    |
|-----------------|---------|-----------|--------|----------|------------------|
| EMIF01-SMIC01F2 | GA      | Flip Chip | 2.8 mg | 5000     | Tape and reel 7" |

## 5 Revision history

**Table 4. Document revision history**

| Date        | Revision | Changes  |
|-------------|----------|--|
| 03-Oct-2006 | 1        | Initial release  |
| 24-Apr-2008 | 2        | Updated values of capacitors in Table 2. C <sub>1</sub> , C <sub>2</sub> , C <sub>3</sub> , C <sub>4</sub> from 0.85 nF to 1 nF, and C <sub>5</sub> from 140 pF to 150 pF. Updated ECOPACK statement. Updated <a href="#">Figure 7</a> , and <a href="#">Figure 10</a> . Reformatted to current standards. |

**Please Read Carefully:**

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

**UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.**

**UNLESS EXPRESSLY APPROVED IN WRITING BY AN AUTHORIZED ST REPRESENTATIVE, ST PRODUCTS ARE NOT RECOMMENDED, AUTHORIZED OR WARRANTED FOR USE IN MILITARY, AIR CRAFT, SPACE, LIFE SAVING, OR LIFE SUSTAINING APPLICATIONS, NOR IN PRODUCTS OR SYSTEMS WHERE FAILURE OR MALFUNCTION MAY RESULT IN PERSONAL INJURY, DEATH, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE. ST PRODUCTS WHICH ARE NOT SPECIFIED AS "AUTOMOTIVE GRADE" MAY ONLY BE USED IN AUTOMOTIVE APPLICATIONS AT USER'S OWN RISK.**

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries.

Information in this document supersedes and replaces all information previously supplied.

The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2008 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan - Malaysia - Malta - Morocco - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

[www.st.com](http://www.st.com)

# Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

[STMicroelectronics:](#)

[EMIF01-SMIC01F2](#)